

Project	IEEE 802.20 Working Group on Mobile Broadband Wireless Access < http://grouper.ieee.org/groups/802/20 >	
Title	802.20 Technology Evaluation Process	
Date Submitted	2003-03-07	
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Re:	802.20 Call for Contributions	
Abstract	This document provides input to 802.20 on current thinking about the air interface evaluation process, as used in several other standards bodies world-wide. Several areas are noted, including system level simulation, channel modeling, and developing industry consensus and confidence in the technical solutions proposed through adopting a process of detailed technical simulation.	
Purpose	This document is provided as input to 802.20 on technology evaluation methods and recommends that 802.20 implement a similar approach so as to develop a solid air interface standard addressing the needs of users and service operators.	
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